

## C1812C222K1RACTU

Aliases (C1812C222K1RAC7800) SMD Comm X7R, Ceramic, 2,200 pF, 10%, 100 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	95 mg
Shelf Life	78 Weeks
MSL	1

2,200 pF

Time is 1000 Hours

100 GOhms

Dimensions	
Chip Size	1812
L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
Т	1mm +/-0.10mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

m +/-0.3mm	Measurement Condition	1 kHz 1.0Vrms
m +/-0.3mm	Tolerance	10%
-/-0.10mm	Voltage DC	100 VDC
m MIN	Dielectric Withstanding Voltage	250 VDC
m +/-0.35mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
80mm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
	Dissipation Factor	2.5% 1 kHz 1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee

**Specifications** 

Insulation Resistance

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

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